S21ME Series

European Safety Standard Approved, Long Creepage Distance Type Phototriac Couplers

- * Lead forming type (I type) of S21ME series is also available. (S21ME3I/ S21ME4I/ S21ME3FI/ S21ME4FI)
- * Taping reel type (P type) of S21ME series is also available. (S21ME3P/S21ME4P/S21ME3FP/S21ME4FP)
- * DIN-VDE0884 approved type is also available as an option.

■ Features

1. Long creepage distance type

(Creepage distance: 8mm or more)

2. Internal insulation distance: 0.5mm or more

3. Description of approved safety standards

(Lead forming type is also registered as

S21ME3/S21ME4.)

Recoginized by UL 1577 (double protection included)

file No. E64380

Approved by VDE, No. 68328

Approved by BSI (BS415: No. 6690, BS7002: No. 7421)

Approved by SEMKO

S21ME3/ **S21ME3F** No. 8705122

S21ME4/S21ME4F No. 8705123

Approved by DEMKO, No. 84857

Approved by EI

S21ME3/ **S21ME3F** No. 099443-01

S21ME4/S21ME4F No. 099444-01

4. Low minimum trigger current

 $(I_{FT}: MAX.7mA)$

5. Built-in zero-cross circuit

(S21ME4/S21ME4F)

6. Lead forming type/ **S21ME3F**, **S21ME4F**

(Distance between lead pins: 10.16mm)

7. High repetitive peak OFF-state voltage

 $(V_{DRM}: MIN. 600V)$

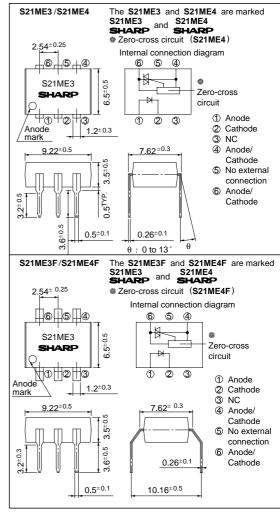
8. High isolation voltage between input and output

 $(V_{iso}: 5000V_{rms})$

■ Applications

1. For triggering medium/high power triac

■ Outline Dimensions (Unit : mm)



■ Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

	Parameter	Symbol	Rating	Unit	
Input	Forward current	I_F	50	mA	
	Reverse voltage	V_R	6	V	
Output	RMS ON-state current	I_{T}	100	mA _{rms}	
	*1Peak one cycle surge current	I surge	1.2	A	
	Repetitive peak OFF-state voltage	V_{DRM}	600	V	
	*2Isolation voltage	V_{iso}	5 000	V _{rms}	
Operating temperature		T opr	- 30 to + 100	°C	
	Storage temperature	T stg	- 55 to + 125	°C	
	*3Soldering temperature	T sol	T _{sol} 260		

^{*1 50}Hz, sine wave

■ Electro-optical Characteristics

 $(Ta = 25^{\circ}C)$

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit	
Input	Forward voltage		$V_{\rm F}$	$I_F = 20mA$	-	1.2	1.4	V
	Reverse current		I_R	$V_R = 3V$	-	-	10-5	A
Output	Repetitive peak OFF-state current		I_{DRM}	$V_{DRM} = Rated$	-	-	10-6	A
	ON-state voltage		V _T	$I_T = 100 \text{mA}$	-	1.7	3.0	V
	Holding current		I_{H}	$V_D = 6V$	0.05	-	3.5	mA
	Critical rate of rise	S21ME3 S21ME3F	dV/dt	$V_{DRM} = 1/\sqrt{2} \cdot Rated$	500	-	-	V/µs
	of OFF-state voltage	S21ME4 S21ME4F			100	-	-	
	Zero-cross voltage	S21ME4 S21ME4F	Vox	Resistance load, I _F = 15mA	-	-	35	V
	Minimum trigger current		I_{FT}	$V_D = 6V$, $R_L = 100\Omega$	-	-	7.0	mA
Transfer charac- teristics	Isolation resistance		R _{ISO}	DC500V, 40 to 60% RH	5 x 10 ¹⁰	1011	-	Ω
	Turn-on time S21M	S21ME3 S21ME3F	t _{on}	$V_D = 6V$, $R_L = 100\Omega$, $I_F = 20mA$	-	40	100	μs
		S21ME4 S21ME4F		f = 50Hz	-	-	1/2	cycle
	Turn-off time	S21ME4 S21ME4F	t off	f = 50Hz	-	-	1/2	cycle

^{*2 40} to 60% RH, AC for 1 minute f = 60Hz

^{*3} For 10 seconds

Fig. 1 RMS ON-state Current vs.
Ambient Temperature

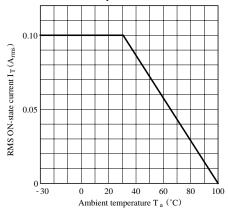


Fig. 3 Forward Current vs. Forward Voltage

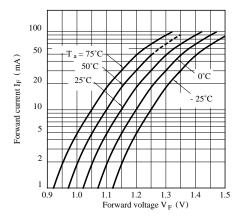


Fig. 5 Relative Repetitive Peak OFF-state Voltage vs. Ambient Temperature

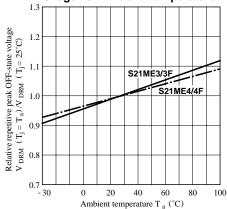


Fig. 2 Forward Current vs.
Ambient Temperature

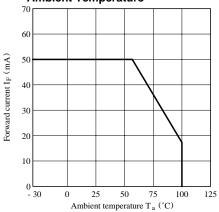


Fig. 4 Minimum Trigger Current vs.
Ambient Temperature

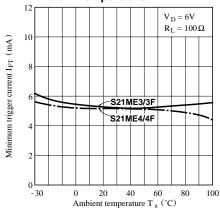


Fig. 6 ON-state Voltage vs.

Ambient Temperature

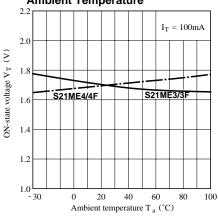


Fig. 7 Holding Current vs. **Ambient Temperature**

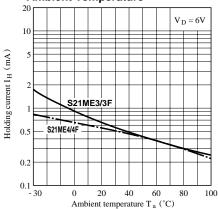


Fig. 8-b Repetitive Peak OFF-state Current vs. OFF-state Voltage

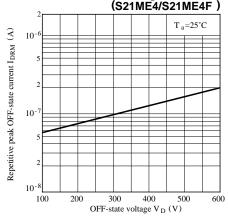


Fig. 9-b Repetitive Peak OFF-state Current vs. Ambient Temperature

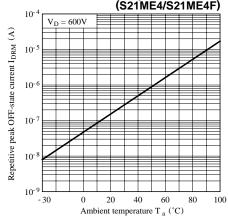


Fig. 8-a Repetitive Peak OFF-state Current

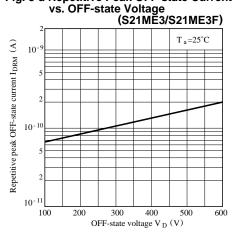


Fig. 9-a Repetitive Peak OFF-state Current vs. Ambient Temperature

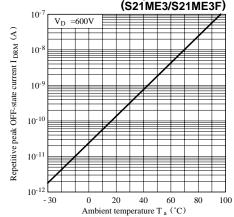


Fig.10 Turn-on Time vs. Forward Current (S21ME3/S21ME3F)

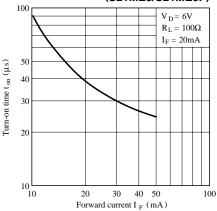
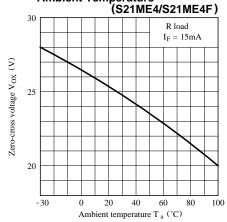
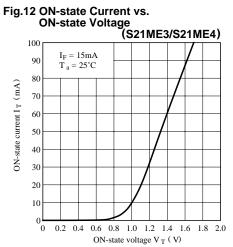


Fig.11 Zero-cross Voltage vs. Ambient Temperature





• Please refer to the chapter "Precautions for Use" (Page 78 to 93).

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 - Traffic signals
 - Gas leakage sensor breakers
 - Alarm equipment
 - Various safety devices, etc.
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